

### **Features**

- $\bullet \quad \text{Very Low FOM $R_{DS(on)}$x $Q_g$} \\$
- Halogen Free. "Green" Device (Note 1)
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

# **Maximum Ratings**

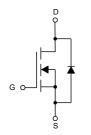
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 5.7°C/W Junction to Case<sup>(Note2)</sup>

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V <sub>DS</sub>	650	V
Gate-Source Volltage	V <sub>GS</sub>	±30	V
Continuous Drain Current	I <sub>D</sub>	20	Α
Pulsed Drain Current <sup>(3)</sup>	I <sub>DM</sub>	60	Α
Total Power Dissipation	P <sub>D</sub>	34	W
Single Pulsed Avalanche Energy <sup>(4)</sup>	E <sub>AS</sub>	485	mJ

#### Note:

- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. Surface Mounted on 1 in² pad area, t ≤10 sec
- 3. Pulse Test: Pulse Width≤300us, Duty cycle ≤2%.

# **Internal Structure and Marking Code**



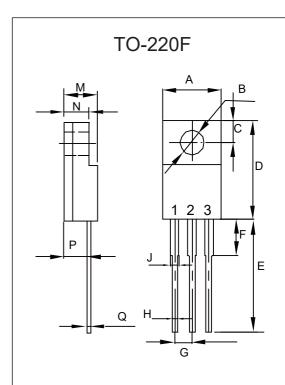
1. Gate 2. Drain

3. Source





# N-CHANNEL MOSFET



DIMENSIONS						
DIM	INCHES		MM		NOTE	
Dilvi	MIN	MAX	MIN	MAX	NOTE	
Α	0.390	0.421	9.90	10.70		
В	0.122	0.130	3.10	3.30	Ф	
С	0.106		2.70		TYP.	
D	0.567	0.642	14.40	16.30		
Е	0.630	0.661	16.00	16.80		
F	0.134	0.150	3.40	3.80		
G	0.092	0.108	2.34	2.74		
Н	0.020	0.035	0.50	0.90		
J	0.043	0.056	1.10	1.42		
M	0.169	0.201	4.30	5.10		
N	0.096	0.104	2.45	2.65		
Р	0.083	0.126	2.10	3.20		
Q	0.016	0.032	0.40	0.80		



# Electrical Characteristics @ 25°C (Unless Otherwise Specified)

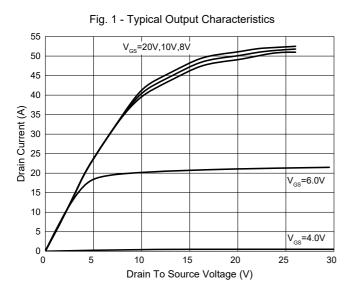
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Static Characteristics	1		ı	1	1	1
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	650			V
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±30V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>C</sub> =25°C			1	μA
Gate-Threshold Voltage (Note 4)	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	2	3	4	V
Drain-Source On-Resistance (Note 4)	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =10A		167	180	mΩ
Gate Resistance (Note 4)	R <sub>G</sub>	f = 1.0MHz Open Drain		2.2		Ω
Dynamic Characteristics (Note 5	j)					
Input Capacitance	C <sub>iss</sub>			1807		
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V,f=1MHz		1214		pF
Reverse Transfer Capacitance	C <sub>rss</sub>			103		
Total Gate Charge	$Q_g$			56		
Gate-Source Charge	$Q_{gs}$	V <sub>DS</sub> =560V,V <sub>GS</sub> =10V,I <sub>D</sub> =20A		12		nC
Gate-Drain Charge	$Q_{gd}$			25		
Turn-On Delay Time	t <sub>d(on)</sub>			30		
Turn-On Rise Time	t <sub>r</sub>	V <sub>DD</sub> =350V,I <sub>D</sub> =20A		55		no
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =25 $\Omega$		167		ns
Turn-Off Fall Time	t <sub>f</sub>			103		
Drain-Source Diode Characte	ristics		•			
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =20A			1.4	V
Continuous Body Diode Current	I <sub>S</sub>				20	Α
Reverse Recovery Time	t <sub>rr</sub>	V <sub>DD</sub> =100V,		332		ns
Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>S</sub> =11A,		4901		nC
Peak Reverse Recovery Current	I <sub>rrm</sub>	di <sub>F</sub> /dt = 100A/μs		31		Α

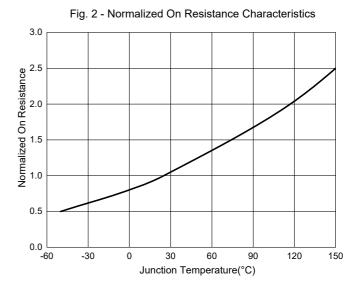
## Note:

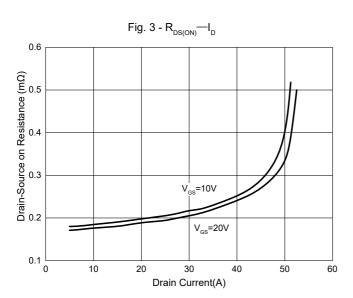
<sup>4.</sup> Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  1% .

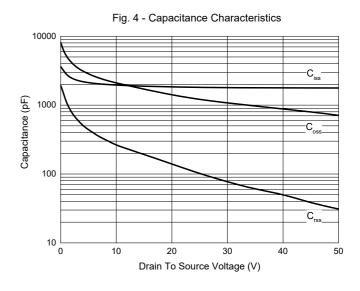
<sup>5.</sup> Guaranteed by Design, not Subject to Production.

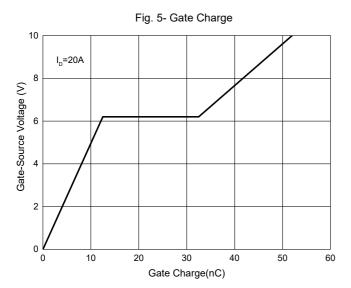












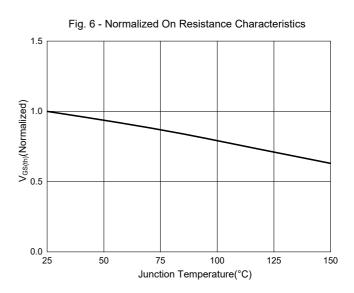
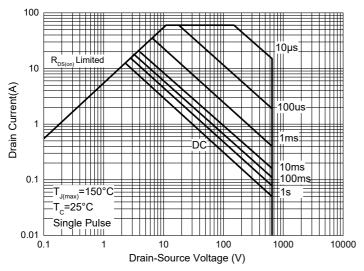




Fig. 7 - Safe Operation Area





# **Ordering Information**

Device	Packing
Part Number-BP	Bulk: 50pcs/Tube; 1Kpcs/Box; 5Kpcs/Ctn

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